

To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

Send any inquiries to <http://www.renesas.com/inquiry>.

Notice

1. All information included in this document is current as of the date this document is issued. Such information, however, is subject to change without any prior notice. Before purchasing or using any Renesas Electronics products listed herein, please confirm the latest product information with a Renesas Electronics sales office. Also, please pay regular and careful attention to additional and different information to be disclosed by Renesas Electronics such as that disclosed through our website.
2. Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
3. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part.
4. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
5. When exporting the products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations. You should not use Renesas Electronics products or the technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations.
6. Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
7. Renesas Electronics products are classified according to the following three quality grades: “Standard”, “High Quality”, and “Specific”. The recommended applications for each Renesas Electronics product depends on the product’s quality grade, as indicated below. You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application categorized as “Specific” without the prior written consent of Renesas Electronics. Further, you may not use any Renesas Electronics product for any application for which it is not intended without the prior written consent of Renesas Electronics. Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for an application categorized as “Specific” or for which the product is not intended where you have failed to obtain the prior written consent of Renesas Electronics. The quality grade of each Renesas Electronics product is “Standard” unless otherwise expressly specified in a Renesas Electronics data sheets or data books, etc.

“Standard”: Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots.

“High Quality”: Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anti-crime systems; safety equipment; and medical equipment not specifically designed for life support.

“Specific”: Aircraft; aerospace equipment; submersible repeaters; nuclear reactor control systems; medical equipment or systems for life support (e.g. artificial life support devices or systems), surgical implantations, or healthcare intervention (e.g. excision, etc.), and any other applications or purposes that pose a direct threat to human life.
8. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
9. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or system manufactured by you.
10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
11. This document may not be reproduced or duplicated, in any form, in whole or in part, without prior written consent of Renesas Electronics.
12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries.

(Note 1) “Renesas Electronics” as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries.

(Note 2) “Renesas Electronics product(s)” means any product developed or manufactured by or for Renesas Electronics.

M50224FP

1.5 Channel Motor Driver-with DC/DC Control

REJ03F0070-0100Z

Rev.1.0

Sep.19.2003

Description

M50224FP is the semiconductor integrated circuit which builds in the Motor drive circuit and DC/DC circuit suitable for the camera etc.

1.5 H bridges, the DC/DC circuit of 5VDC/DC, and AE operation circuit were built in one tip by adoption of a detailed CMOS process.

The reduction in power consumption and the miniaturization are considered as the high composition of the flexibility realized with one chip.

Features

- Minute CMOS process acceptance.Low consumption
- 1.5 full swing voltage drive H Bridge circuit built-in (PWM drive correspondence)
- DC/DC circuit built-in of 5V
- One AE operation circuit built-in AE (A sensor corresponds to amorphous and SPD)
- Low voltage incorrect operation prevention circuit thermole shutdown circuit built-in
- A thermometer, with a power save function

Application

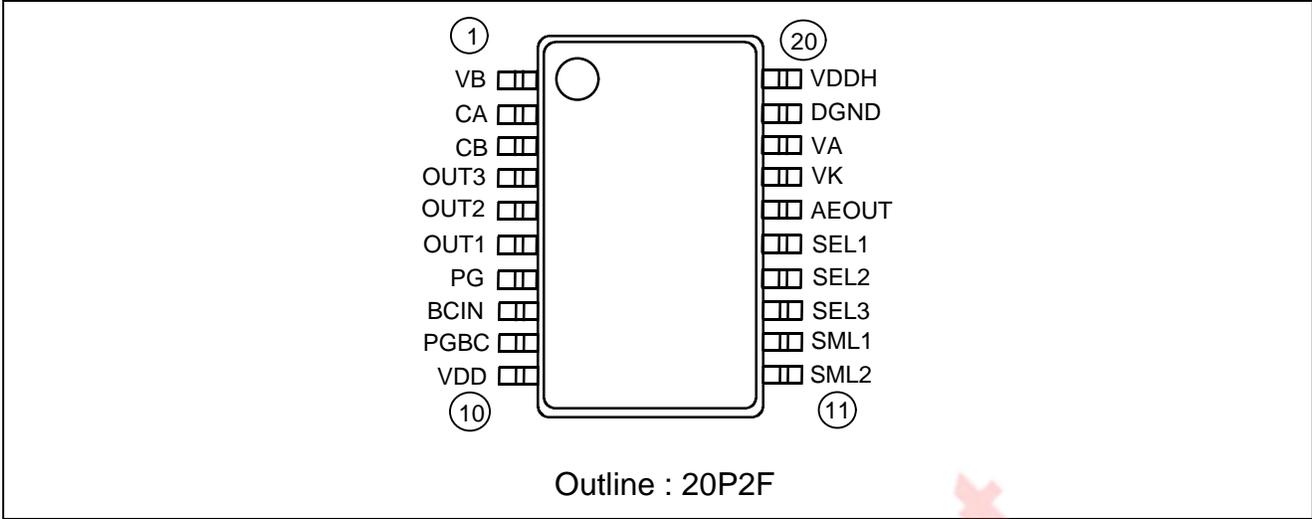
motor driver for cameras etc

Recommend Operating Condition

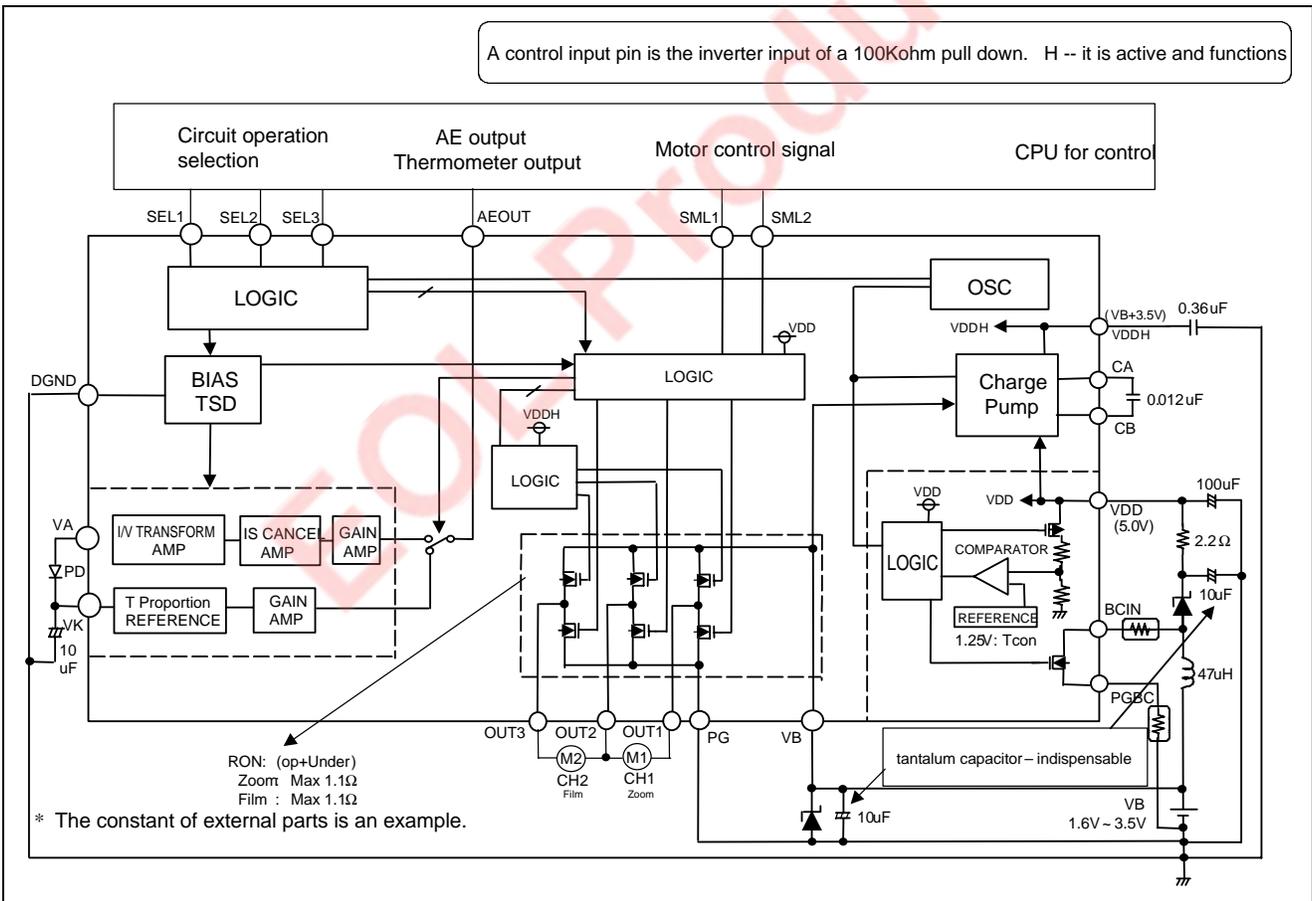
Supply voltage range..... VB:1.6V to 3.5V

Rated supply voltage VB:3.0V

Pin Configuration



Block Diagram



Absolute Maximum Ratings

(Ta=25°C, unless otherwise noted)

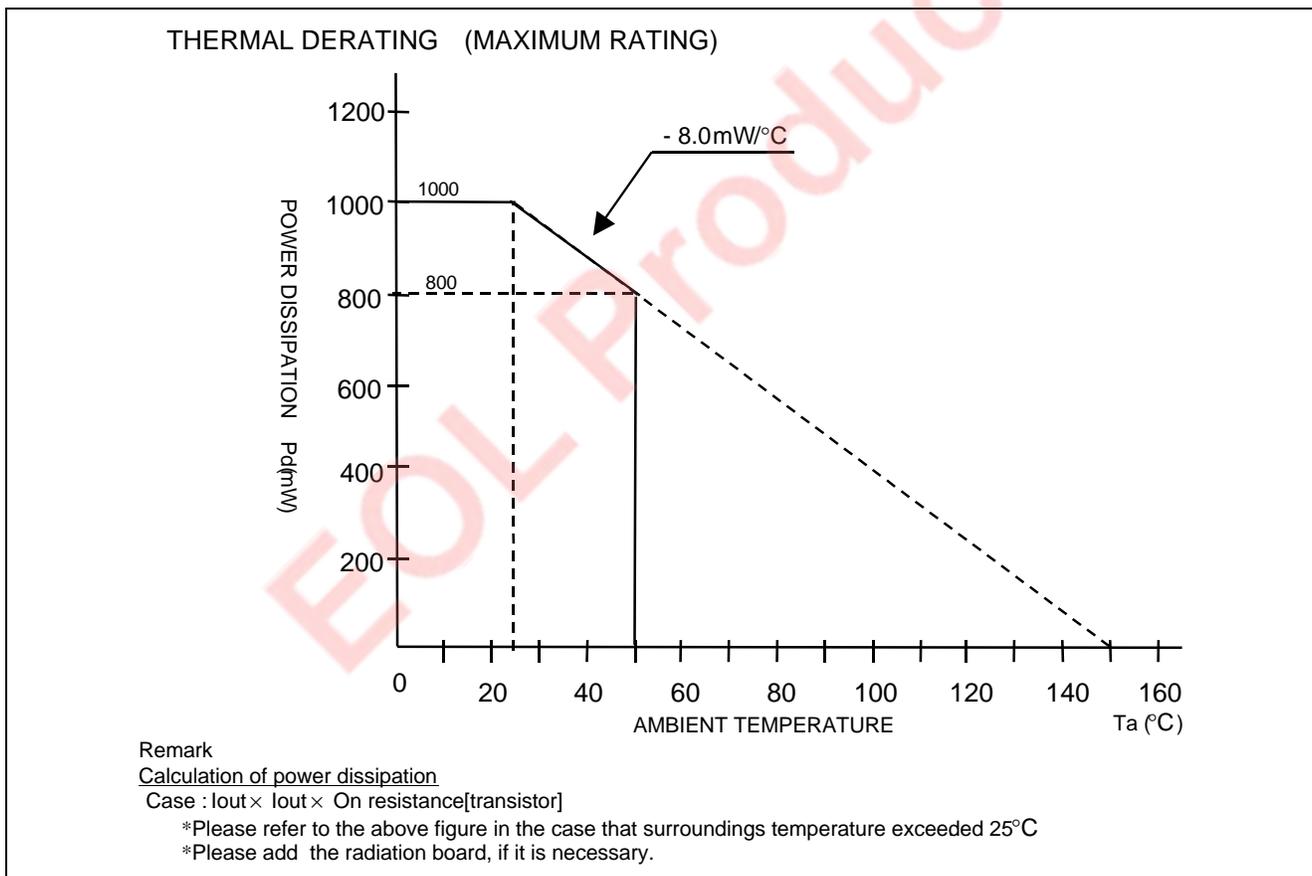
Parameter	Symbol	Ratings	Unit	Remark
Supply voltage1	VB	3.5	V	Note1
Supply voltage2	VDD	6.5	V	Note1
Supply voltage3	VDDH	VB+4.5	V	Note1
Voltage between BCIN and PGBC	VDSS	15	V	Note1 (VGS=0V)
Power dissipation	Pd	1000	mW	Note2 (Ta=25° C)
Thermal derating	Kθ	-8.0	mW/° C	Note2 (Ta=25° C)
Pin input Voltage	Vin	0 to VDD+0.3	V	Note3
Operating temperature	Topr	-10 to 50	° C	
Storage temperature	Tstg	-40 to 150	° C	

note1: As a principle, do not provide reversely

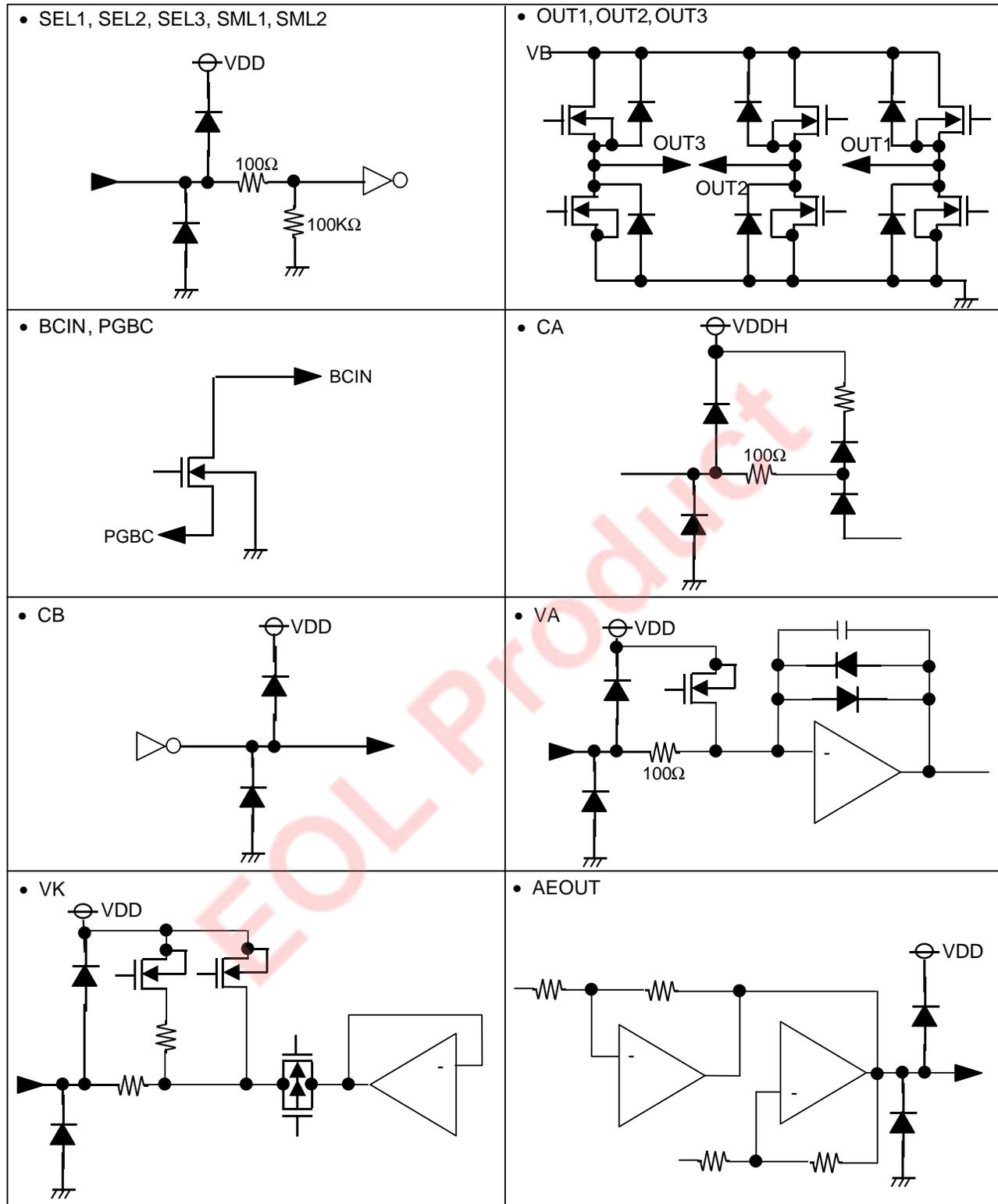
note2: Glass epoxy circuit board: 70mm x 70mm x 1.6mm 1layer circuit board Cu Share 10%

note3: As a principle, do not provide over supply voltage or under ground voltage

Thermal Derating (Maximum Rating)



I/O Circuit Diagram



Electrical Characteristics

(Ta =25°C, VB=3.0V, VDD=5.0V, unless otherwise noted)

Parameter	Symbol	Test condition	Limits			Unit	Note
			MIN	TYP	MAX		
Voltage range of operation	VB		2.0	3.0	3.5	V	
Consumption current	Current at the time of standby	IB1 SEL1:L SEL2:L SEL3:L	-	0.1	5	μA	
	Usual consuming current 1	IDD1 Only a DC/DC circuit is turned ON. SEL1:H SEL2:L SEL3:L	-			mA	
	Usual consuming current 2	IDD2 DC/DC+AE+MD circuit ON SEL1:H SEL2:L SEL3:H	-			mA	
Input terminal	Hi level input current	IiH VIN=VDD=5.0V	25	50	100	μA	Note1
	Lo level input current	IiL	-1.0	-	-	μA	
	Input pull down resistance	RIND	50	100	200	KΩ	
	Hi level input voltage	VIH VDD=4.5 to 5.5V	VDD×0.7	-	VDD	V	
	Lo level input voltage	VIL VDD=4.5 to 5.5V	0	-	VDD ×0.3	V	
DC/DC Circuit	Oscillation frequency	fosc VDD=5.0V	44	63	82	kHz	Note2
	DUTY	DUTY VDD=5.0V		75		%	
	Operating start Voltage	Vstart1 VB voltage	-	-	2.0	V	
	Operating stop Voltage	Vstop1 VB voltage	-	-	1.0	V	
	Output voltage	Vout VDD voltage	4.7	5.0	5.3	V	
	Input stability	ΔVout1 VB=2.0V to 3.3V IDD=50mA	-	-	100	mV	
	Load stability	ΔVout2 VB=2.85V IDD=100mA	-	-	100	mV	
	Maximum output current	Iout VB=2.85V VDD≥4.5V	100	-	-	mA	
Charge pump circuit	Oscillation frequency	fosc2 VDD=5.0V	150	227	320	kHz	Note3
	DUTY	DUTY2 VDD=5.0V		50		%	
	Operating start Voltage	Vstart2 VDD voltage	4.5	5.0	5.3	V	
	Output voltage	Vout2 VDDH voltage	VB+2.6	VB+3.3	VB+4.5	V	
Motor driver(1, 2)	Operating voltage	VBDCM VB voltage	1.6	-	3.5	V	
	ON Resistance RVON 1	RVON 1 Io=0.5A, VB=3V, VDD=5V, VDDH=5.5V	-	0.75	1.1	Ω	Note4
	Maximum output current	Iomax T < ***S	1.8	-	-	A	
	Continual maximum output current	Iocont	500	-	-	mA	
	Turn on time	TvON RM=5.0Ω	-	0.5	2	μs	
	Turn off time	TvOFF Fig. 1	-	0.1	0.5	μs	
	Output rise time Tr	Tr	-	0.3	1.0	μs	
Output fall time Tf	Tvf	-	0.01	0.2	μs		

(Ta =25°C, VB=3.0V, VDD=5.0V, unless otherwise noted)

Parameter	Symbol	Test condition	Limit			Unit	Note	
			MIN	TYP	MAX			
Temperature output absolute value	VTE		.	2713	3392	mV		
AE circuit (Thermometer)	Temperature output power supply voltage change 1	dVTE1	VDD=5.5V	-45	-	45	mV	
	Temperature output power supply voltage change 2	dVTE2	VDD=4.5V	-45	-	45	mV	
	Temperature output voltage load change	dVTE3	Io=-0.2mA	-20	-	20	mV	
	The amount of temperature output change	dVTE4	The Amount of Change (-10 to 50° C)	-22.7	-22.0	-19.1	mV	
AE circuit (Light measurement circuit)	Input range	IA		50p	-	120u	A	
	Light measurement output absolute value	VAE	IA=10nA		1914		mV	
	The amount of change per two step	dEVA1	IA=10nA -> 40nA		-242		mV	
	Output linearity 1	DEVS1	IA=50pA to 1.6nA	-30	-	30	%	
	Output linearity 2	DEVS2	IA=1.6nA to 410nA	-23	-	23	%	
	Output linearity 3	DEVS3	IA=410nA to 13.1μA	-23	-	23	%	
Output linearity 4	DEVS4	IA=13.1μA to 120μA	-30	-	30	%		
Power supply response	Trs	IA=50pA		-	-	50	ms	
TSD	thermole shutdown temperature	TTSD	Tip temperature in case H bridge output turns off		150		° C	Note5

Note1: Input terminal : 11 to15 PIN

Note2: L=47μH, C=100uF

Note3: Since it is a power supply only for the insides of IC, please do not connect a charge pump circuit to others.

Note4: The sum of upper and lower sides side ON resistance.

ON resistance is changed with VB, VDD, and VDDH voltage.

Note5: A shipment test is not performed although the TSD circuit characteristic presents reference data.

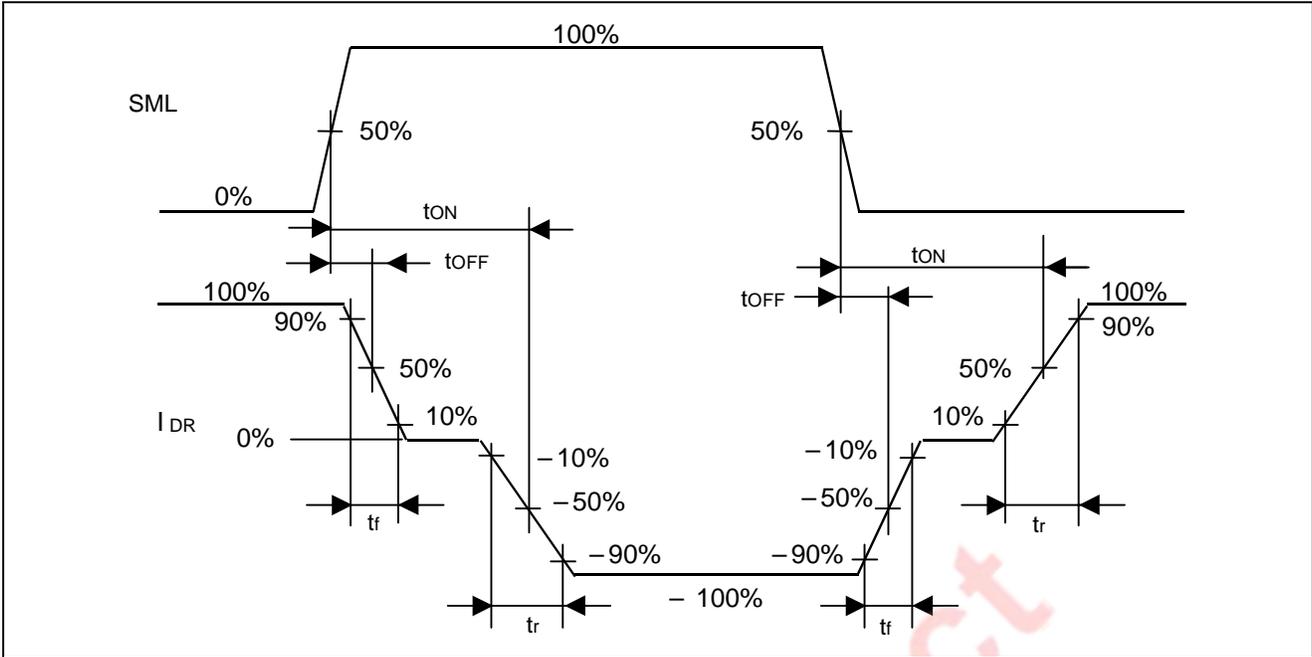
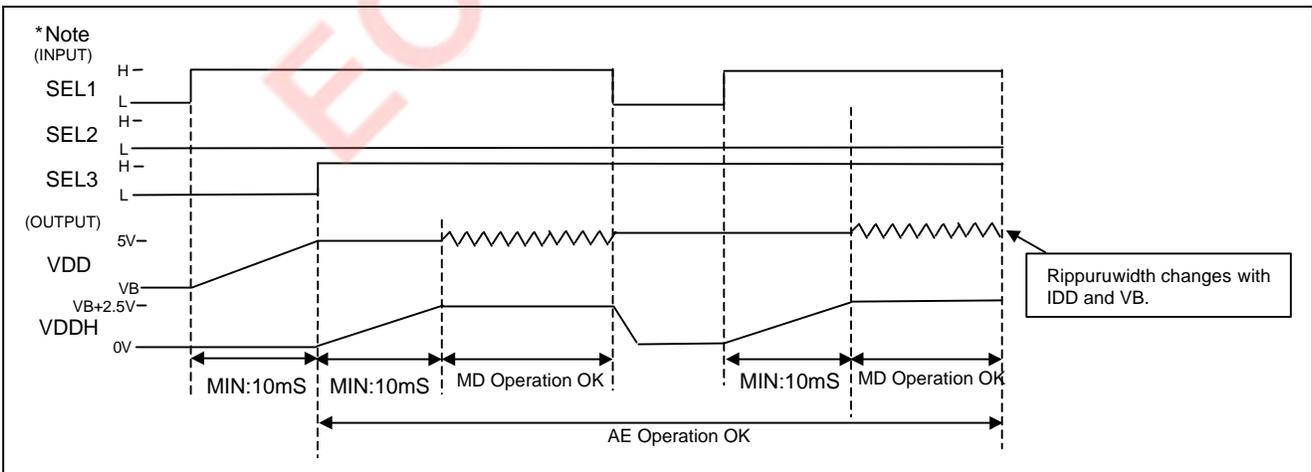


Fig 1 H bridge part switching characteristic waveform

SEL Truth value table

SEL1	SEL2	SEL3	The contents of control
L	L	L	Standby
H	L	L	Only a DC/DC circuit is turned ON (*note)
H	L	H	DC/DC + AE circuit ON + motor1 control (AEOUT: right out)
H	H	H	DC/DC + AE circuit ON + motor2 control(AEOUT: right out)
H	H	L	DC/DC + AE circuit ON + shutter control(AEOUT : temperature out)
L	L	H	Only AE circuit ON (AEOUT: right out)
L	H	H	Only AE circuit ON (AEOUT: right out)
L	H	L	Only AE circuit ON (AEOUT : temperature out)

*1. SEL1:DC/DC and Charge pump control (L=OFF, H=ON)



Motor control Truth value table

	INPUT					MOTOR1	MOTOR2	Shutter	MOTOR Each output		
	SEL1	SEL2	SEL3	SML1	SML2				OUT1	OUT2	OUT3
MOTOR1 Control	H	L	H	L	L	Standby	Standby	Standby	OFF	OFF	OFF
	H	L	H	H	L	Forward Rotation	Standby	Standby	L	H	OFF
	H	L	H	L	H	Reverse	Standby	Standby	H	L	OFF
	H	L	H	H	H	Brake	Standby	Standby	H	H	OFF
MOTOR2 Control	H	H	H	L	L	Standby	Standby	Standby	OFF	OFF	OFF
	H	H	H	H	L	Standby	Forward Rotation	Standby	OFF	H	L
	H	H	H	L	H	Standby	Reverse	Standby	OFF	L	H
	H	H	H	H	H	Standby	Brake	Standby	OFF	H	H
Shutter Control	H	H	L	L	L	Standby	Standby	Standby	OFF	OFF	OFF
	H	H	L	H	L	Standby	Standby	Forward Rotation	OFF	OFF	L
	H	H	L	L	H	Standby	Standby	Reverse	OFF	OFF	H
	H	H	L	H	H	Standby	Standby	Brake	OFF	OFF	H

- *: Please pass through the Brake or Stand-by mode by all means in case of moving from forward rotation to Reverse rotation or from Reverse rotation to forward rotation by the motor control.
(ex.) Forward rotation -> Brake -> Reverse rotation, Reverse rotation -> Stand-by -> Forward rotation

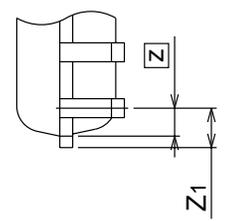
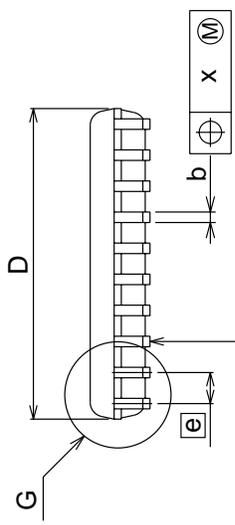
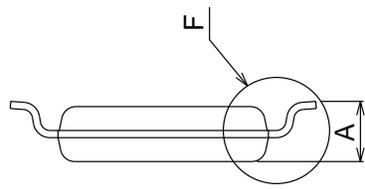
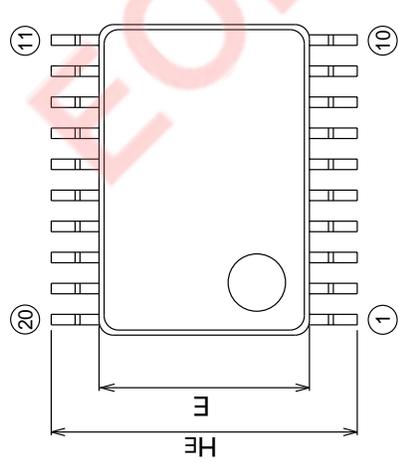
Package Dimensions

20P2F-A

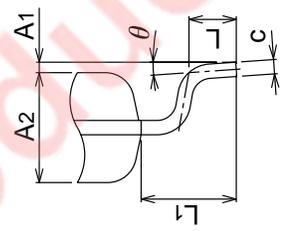
(MMP)

Plastic 20pin 255mil SSOP

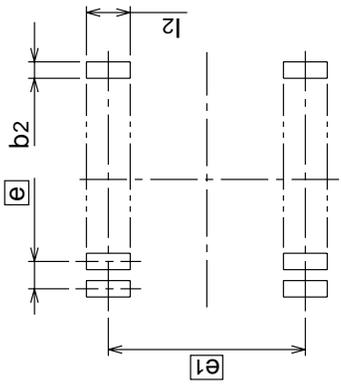
EIAJ Package Code SSOP20-P-255-0.65	JEDEC Code —	Weight(g) —	Lead Material Cu Alloy
--	-----------------	----------------	---------------------------



Detail F



Detail F



Recommended Mount Pad

Symbol	Dimension in Millimeters		
	Min	Norm	Max
A	—	—	1.45
A1	0	0.1	0.2
A2	—	1.15	—
b	0.17	0.22	0.32
c	0.13	0.15	0.2
D	6.4	6.5	6.6
E	4.3	4.4	4.5
e	—	0.65	—
HE	6.2	6.4	6.6
L	0.3	0.5	0.7
L1	—	1.0	—
Z	—	0.325	—
Z1	—	—	0.475
x	—	—	0.13
y	—	—	0.1
θ	0°	—	10°
b2	—	0.35	—
e1	—	5.8	—
l2	1.0	—	—

Renesas Technology Corp. Sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

Keep safety first in your circuit designs!

1. Renesas Technology Corp. puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage.
Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials

1. These materials are intended as a reference to assist our customers in the selection of the Renesas Technology Corp. product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Renesas Technology Corp. or a third party.
 2. Renesas Technology Corp. assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.
 3. All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Renesas Technology Corp. without notice due to product improvements or other reasons. It is therefore recommended that customers contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor for the latest product information before purchasing a product listed herein.
The information described here may contain technical inaccuracies or typographical errors.
Renesas Technology Corp. assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.
Please also pay attention to information published by Renesas Technology Corp. by various means, including the Renesas Technology Corp. Semiconductor home page (<http://www.renesas.com>).
 4. When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Renesas Technology Corp. assumes no responsibility for any damage, liability or other loss resulting from the information contained herein.
 5. Renesas Technology Corp. semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
 6. The prior written approval of Renesas Technology Corp. is necessary to reprint or reproduce in whole or in part these materials.
 7. If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.
Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.
 8. Please contact Renesas Technology Corp. for further details on these materials or the products contained therein.
-



RENESAS SALES OFFICES

<http://www.renesas.com>

Renesas Technology America, Inc.
450 Holger Way, San Jose, CA 95134-1368, U.S.A
Tel: <1> (408) 382-7500 Fax: <1> (408) 382-7501

Renesas Technology Europe Limited.
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, United Kingdom
Tel: <44> (1628) 585 100, Fax: <44> (1628) 585 900

Renesas Technology Europe GmbH
Dornacher Str. 3, D-85622 Feldkirchen, Germany
Tel: <49> (89) 380 70 0, Fax: <49> (89) 929 30 11

Renesas Technology Hong Kong Ltd.
7/F., North Tower, World Finance Centre, Harbour City, Canton Road, Hong Kong
Tel: <852> 2265-6688, Fax: <852> 2375-6836

Renesas Technology Taiwan Co., Ltd.
FL 10, #99, Fu-Hsing N. Rd., Taipei, Taiwan
Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology (Shanghai) Co., Ltd.
26/F., Ruijin Building, No.205 Maoming Road (S), Shanghai 200020, China
Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

Renesas Technology Singapore Pte. Ltd.
1, Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632
Tel: <65> 6213-0200, Fax: <65> 6278-8001